

A new electro-thermal aging model

based on trapping and De-trapping process in polymeric materials

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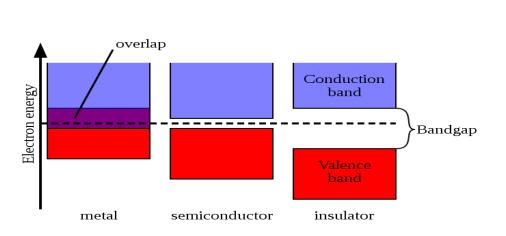
Outlines

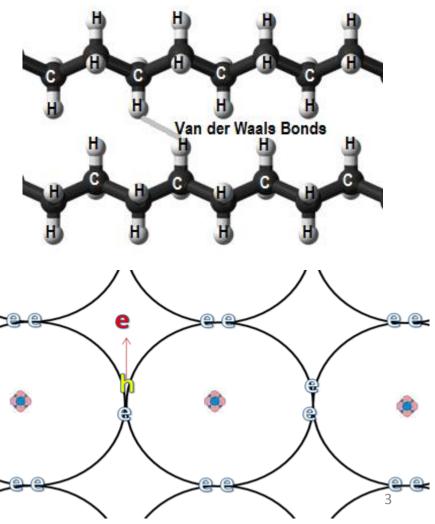
- Energy barrier and its affected parameters
- Producing the energy term
- Kinetic equation of the trapping and detrapping process
- Developing the model

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> Energy Barrier

$$\begin{pmatrix}
H & H \\
-C & -C \\
H & H
\end{pmatrix}_{n}$$

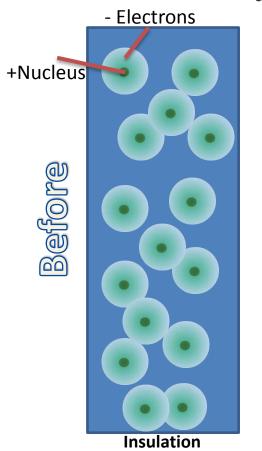


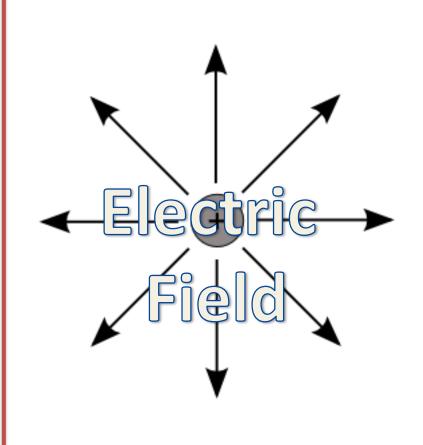


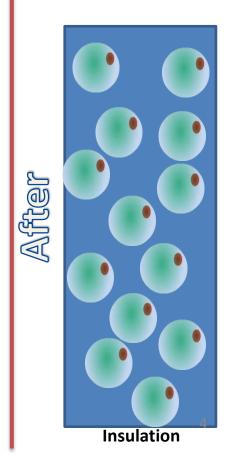


> Affected Parameters

(1) Permittivity of the insulation material



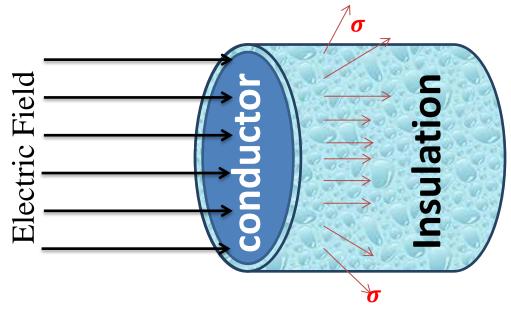






> Affected Parameters

(2) **Tension** of the insulation material



mechanical stress (σ) induced when the electric filed is applied

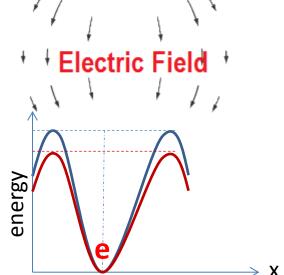


Producing the energy term

The mechanical stress induced by electrostatic field is:

$$\sigma = \frac{1}{2} \varepsilon E^2$$

The energy barrier is lowered by the mechanical energy as:



$$W_m = \frac{1}{2Y}\sigma^2 = \frac{\varepsilon^2 E^4}{8Y}$$



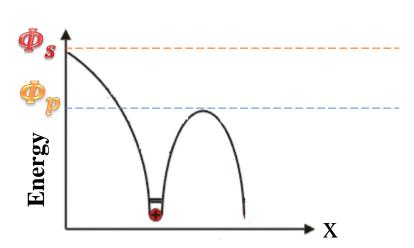
> Current density



The current has a different mechanism on

interfaces than the bulk

$$J = A_0 T^2 \exp\left(-\frac{\Phi_D - \Phi_{eff}}{kT}\right)$$



$$\Phi_{eff} = \Phi_s = \left(\frac{q^3 E}{4\pi\varepsilon}\right)^{1/2}$$
 Schottky mechanism

$$\Phi_{eff} = 2\Phi_s = \Phi_p$$
 Poole–Frenkel mechanism



Kinetic Equation

Kinetic equation of trapping concentration

$$\frac{dn_T}{dt} = -K_T n_T + K_D n_D$$

Kinetic equation of detrapping concentration

$$\frac{dn_D}{dt} = -K_D n_D + K_T n_T$$

where
$$K_T = \frac{\sigma_T}{q} A_0 T^2 \exp\left(-\frac{\Phi_D - \Phi_{eff}}{kT}\right)$$

$$\mathbf{K}_{\mathbf{D}} = N_c v_{th} \sigma_c \exp\left(-\frac{E_t - W_m}{kT}\right)$$



Kinetic Equation

The progress of detrapping process can be described through a normalized variable X as:

$$X = \frac{n_D}{N}$$

where $(N = n_T + n_D)$ is the total concentration of trapping and detrapping. Therefore,

$$1 - X = \frac{n_T}{N}$$



Kinetic Equation

The reaction kinetics can be written in term of X as:

$$\frac{dX}{dt} = K_T - (K_T + K_D)X$$

Assuming the insulation is un-trapped at t=0, we can reach:

$$X(t) = C\{1 - \exp[-(K_T + K_D)t]\}$$
 where $C = \frac{K_T}{K_T + K_D}$

C is the equilibrium parameter, and at threshold the electric field is described as: $C(E_{th}, T_{th}) = C^*$



> The life expression

The corresponding life expression can be described by setting $X(t) = C^*$, which will lead to:

$$L(T, E) = (K_T + K_D)^{-1} \ln \left[\frac{C}{C - C^*} \right]$$

Or in another form:

$$L(T,E) = \left[\frac{q * \exp(\frac{\Phi_D + E_t}{kT})}{\sigma_T A_0 T^2 \exp(\frac{E_t + \Phi_{eff}}{kT}) + q N_c v_{th} \sigma_c \exp(\frac{\Phi_D + W_m}{kT})} \right] \times \ln \left[\frac{C}{C - C^*} \right]$$



> The life expression

$$L(T, E) = \left[\frac{q * \exp(\frac{\Phi_D + E_t}{kT})}{\sigma_T A_0 T^2 \exp(\frac{E_t + \Phi_{eff}}{kT}) + q N_c v_{th} \sigma_D \exp(\frac{\Phi_D + W_m}{kT})} \right] \times \ln\left[\frac{C}{C - C^*}\right]$$

 v_{th} is the electron thermal velocity = $\sqrt{3kT/m}$

 N_c is the effective density of states in the conduction band = $2(2\pi m^{e^*}kT/h^2)^{3/2}$

 A_0 is the emission constant for Richardson-Dushman effect = $(1 - R) 4\pi q m_e k^2/h^3$



> The life expression

 σ_T is the trapping cross section. It is calculated from equation

$$K_T = \frac{\sigma_T}{q} A_0 T^2 \exp\left(-\frac{\Phi_D - \Phi_{eff}}{kT}\right)$$

where K_T is calculated from

$$1 - X(t) = \frac{n_T}{N} = 1 - \frac{K_T}{K_T + K_D} \{ 1 - exp[-(K_T + K_D)t] \}$$

where $n_T = Q_T/(S*d*q)$



> The life expression

 σ_D is the detrapping cross section. It is calculated from equation

$$\mathbf{K}_{\mathbf{D}} = N_c v_{th} \sigma_c \exp\left(-\frac{E_t - W_m}{kT}\right)$$

where K_D is calculated from

$$X(t) = \frac{n_D}{N} = \frac{K_T}{K_T + K_D} \{1 - exp[-(K_T + K_D)t]\}$$

where $n_D = Q_D/(S*d*q)$



> Conclusion

- Deal with electrode-insulation interfaces and bulk of the insulation
- Consider space charge as an explicit affected parameter for the aging process
- Comprehensive of the main mechanisms such as mechanical stress, material strain, space charge, trap depth and movement of the electrons as trapping and detrapping.

